



#### 20V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

### **Product Summary**

BVDSS	Rds(ON) Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C
20V	$2.0 \text{m}\Omega$ @ V <sub>GS</sub> = $4.5 \text{V}$	27A
	$2.6$ m $\Omega$ @ V <sub>GS</sub> = $2.5$ V	23A

### **Description**

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

### **Applications**

- Backlighting
- Power management functions
- DC-DC converters

#### **Features and Benefits**

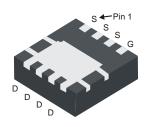
- Low Rds(ON) Ensures On State Losses are Minimized
- Small Form Factor, Thermally Efficient Package Enables Higher Density End Products
- Occupies Just 33% of the Board Area Occupied by SO-8 Enabling Smaller End Product
- 100% Unclamped Inductive Switching (UIS) Test in Production – Ensures More Reliable and Robust End Application
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

#### **Mechanical Data**

- Package: PowerDI<sup>®</sup>3333-8
- Package Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminal Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.072 grams (Approximate)

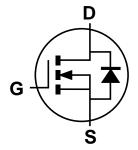
PowerDI3333-8



**Bottom View** 



Top View



**Equivalent Circuit** 

### **Ordering Information** (Note 4)

Part Number	Pankaga	Packing		
Fait Number	Package	Qty.	Carrier	
DMN22M5UFG-7	PowerDI3333-8	2,000	Tape & Reel	
DMN22M5UFG-13	PowerDI3333-8	3,000	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

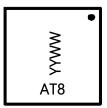
PowerDI is a registered trademark of Diodes Incorporated.



### **Marking Information**

Site 1

#### PowerDI3333-8



AT8= Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 22 = 2022) WW = Week Code (01 to 53)

PowerDI3333-8

X X X X X

AT8 = Product Type Marking Code
YWX = Date Code Marking
Y = Year (ex: 2 = 2022)
W = Week (ex: a = Week 27; z Represents Week 52 and 53)
X = Internal Code (ex: U = Monday)

Date Code Key

Year	2018	 2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	8	 2	3	4	5	6	7	8	9	0	1

Week	1-26	27-52	53
Code	A-Z	a-z	z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	Т	U	V	W	X	Υ	Z

### **Maximum Ratings** (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	20	V		
Gate-Source Voltage			Vgss	±12	V
Continuous Dusin Compant (Note C) V 4 EV	Steady	T <sub>A</sub> = +25°C	- I <sub>D</sub>	24	Δ.
Continuous Drain Current (Note 6) V <sub>GS</sub> = 4.5V	State	T <sub>A</sub> = +70°C		19	A
Continuous Dusin Compant (Note 7) V 4 FV	Steady State	T <sub>C</sub> = +25°C	- I <sub>D</sub>	27	^
Continuous Drain Current (Note 7) V <sub>GS</sub> = 4.5V		T <sub>C</sub> = +70°C		22	А
Maximum Continuous Body Diode Forward Current	(Note 6)		Is	3	Α
Pulsed Drain Current (380µs Pulse, Duty Cycle = 19	6)		I <sub>DM</sub>	500	Α
Pulsed Body Diode Forward Current (380µs Pulse, I	Ism	500	Α		
Avalanche Current, L = 0.2mH (Note 8)	IAS	30	Α		
Repetitive Avalanche Energy, L = 0.2mH (Note 8)	Eas	175	mJ		

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	0.6	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	127	°C/W
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	PD	2.2	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	RθJA	56	°C/W
Thermal Resistance, Junction to Case (Note 7)		R <sub>θ</sub> JC	1.7	°C/W
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

Notes:

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 7. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 8. Ias and Eas ratings are based on low frequency and duty cycles to keep  $T_J = +25$ °C.

DMN22M5UFG
Document number: DS40908 Rev. 3 - 2



# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

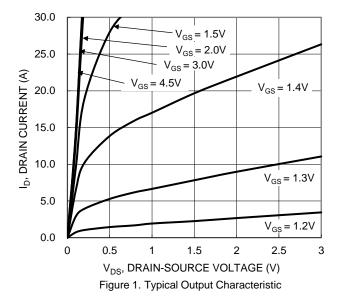
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)						•	
Drain-Source Breakdown Voltage	BVDSS	20		_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	IDSS	_	_	1	μΑ	V <sub>DS</sub> = 16V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.5	_	1.3	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance	D	_	1.5	2.0	mΩ	$V_{GS} = 4.5V, I_D = 13.5A$	
Static Dialif-Source Off-Resistance	RDS(ON)	_	2.0	2.6	11122	$V_{GS} = 2.5V, I_D = 13.5A$	
Diode Forward Voltage	VsD	_	_	1.2	V	V <sub>G</sub> S = 0V, I <sub>S</sub> = 2A	
DYNAMIC CHARACTERISTICS (Note 10)						•	
Input Capacitance	Ciss	_	3926	_	pF	.,	
Output Capacitance	Coss	_	710	_	pF	$V_{DS} = 10V, V_{GS} = 0V,$ f = 1MHz	
Reverse Transfer Capacitance	Crss	_	538	_	pF	-1 = 11VII 12	
Gate Resistance	Rg	_	0.9	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	53	_	nC		
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	99	_	nC	101/ 1 07/	
Gate-Source Charge	Qgs	_	3.7	_	nC	V <sub>DS</sub> = 16V, I <sub>D</sub> = 27A	
Gate-Drain Charge	Qgd	_	24.4	_	nC		
Turn-On Delay Time	t <sub>D(ON)</sub>	_	8.1	_	ns		
Turn-On Rise Time	t <sub>R</sub>	_	22.5	_	ns	Vgs = 5V, Vps = 10V,	
Turn-Off Delay Time	tD(OFF)	_	72.1		ns	$R_g = 4.7\Omega$ , $I_D = 13.5A$	
Turn-Off Fall Time	t <sub>F</sub>	_	44.5	_	ns	1	
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	23.3	_	ns	I <sub>F</sub> = 13.5A, di/dt = 100A/μs	
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	_	11.5	_	nC	I <sub>F</sub> = 13.5A, di/dt = 100A/µs	

Notes:

<sup>9.</sup> Short duration pulse test used to minimize self-heating effect.

<sup>10.</sup> Guaranteed by design. Not subject to product testing.





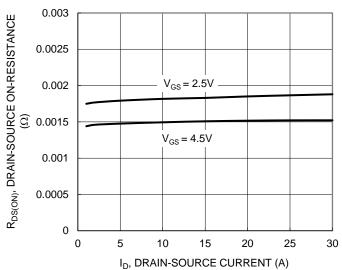


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

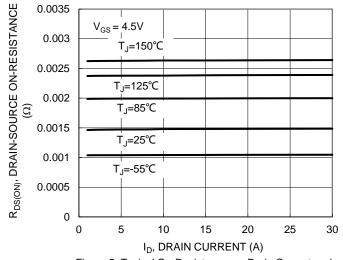


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

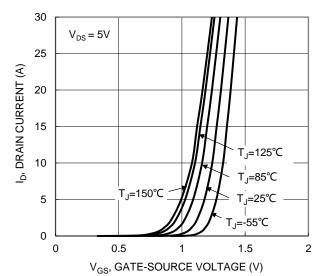


Figure 2. Typical Transfer Characteristic

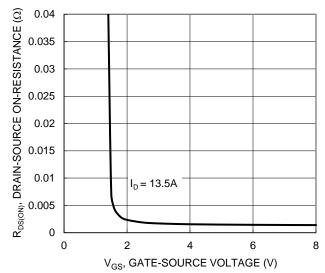


Figure 4. Typical Transfer Characteristic

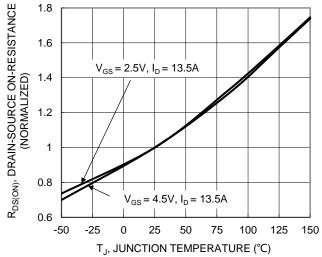


Figure 6. On-Resistance Variation with Junction Temperature

125

150

100



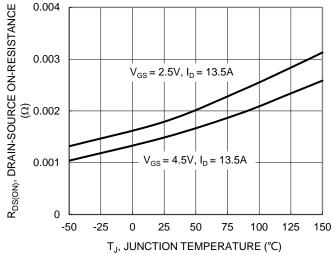


Figure 7. On-Resistance Variation with Junction Temperature

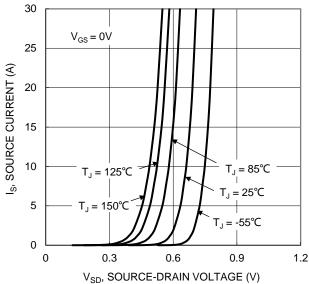
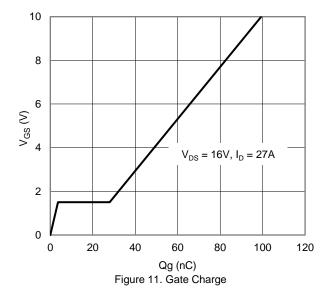


Figure 9. Diode Forward Voltage vs. Current



T<sub>J</sub>, JUNCTION TEMPERATURE (°C) Figure 8. Gate Threshold Variation vs. Junction Temperature

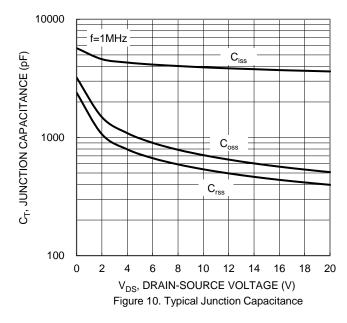
50

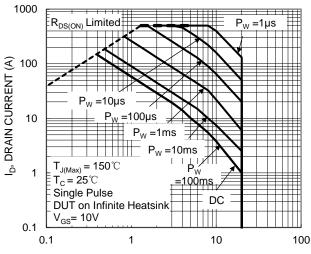
75

25

-50

-25





V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



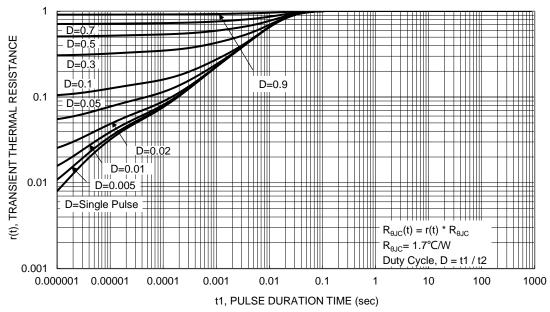


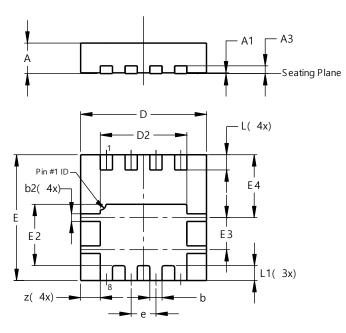
Figure 13. Transient Thermal Resistance



### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI3333-8

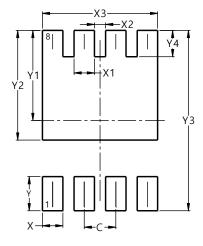


	Powerl	DI3333-	-8
Dim	Min	Max	Тур
Α	0.75	0.85	0.80
A1	0.00	0.05	0.02
A3	_	_	0.203
b	0.27	0.37	0.32
b2	0.15	0.25	0.20
D	3.25	3.35	3.30
D2	2.22	2.32	2.27
E	3.25	3.35	3.30
E2	1.56	1.66	1.61
E3	0.79	0.89	0.84
E4	1.60	1.70	1.65
е	1	-	0.65
L	0.35	0.45	0.40
L1	_	_	0.39
Z	_	_	0.515
All I	Dimens	sions ir	n mm

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### PowerDI3333-8



Dimensions	Value (in mm)
С	0.650
X	0.420
X1	0.420
X2	0.230
Х3	2.370
Υ	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540



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